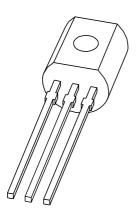
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS5350S50 V low V_{CEsat} PNP transistor

Product data sheet Supersedes data of 2001 Nov 19



50 V low V_{CEsat} PNP transistor

PBSS5350S

FEATURES

- High power dissipation (830 mW)
- Ultra low collector-emitter saturation voltage
- 3 A continuous current
- · High current switching
- Improved device reliability due to reduced heat generation.

APPLICATIONS

- · Medium power switching and muting
- · Linear regulators
- DC/DC convertor
- · Supply line switching circuits
- · Battery management applications
- · Strobe flash units
- Heavy duty battery powered equipment (motor and lamp drivers).

DESCRIPTION

PNP low V_{CEsat} transistor in a SOT54 plastic package. NPN complement: PBSS4350S.

MARKING

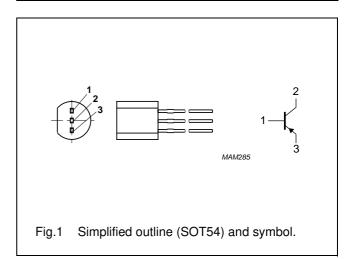
TYPE NUMBER	MARKING CODE
PBSS5350S	S5350S

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V_{CEO}	collector-emitter voltage	-50	V
I _C	collector current (DC)	-3	Α
I _{CM}	peak collector current	-5	Α
R _{CEsat}	equivalent on-resistance	<150	mΩ

PINNING

PIN	DESCRIPTION
1	base
2	collector
3	emitter



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-60	V
V _{CEO}	collector-emitter voltage	open base	_	-50	٧
V_{EBO}	emitter-base voltage	open collector	_	-6	٧
I _C	collector current (DC)		_	-3	Α
I _{CM}	peak collector current		-	- 5	Α
I _{BM}	peak base current		-	-1	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	830	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

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Note

1. Device mounted on a printed-circuit board, single sided copper, tinplated and standard footprint.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to	in free air; note 1	150	K/W
	ambient			

Note

1. Device mounted on a printed-circuit board, single sided copper, tinplated and standard footprint.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0$	-	_	-100	nA
		$V_{CB} = -50 \text{ V}; I_E = 0; T_j = 150 \text{ °C}$	-	-	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	-	_	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}$	200	_	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}; \text{ note 1}$	200	-	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -2 \text{ A}; \text{ note 1}$	100	-	_	
V _{CEsat}	collector-emitter saturation	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	_	-100	mV
	voltage	$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	-	-	-180	mV
		$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	-	-	-300	mV
R _{CEsat}	equivalent on-resistance	$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	-	120	<150	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	_	_	-1.2	V
V_{BE}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}; \text{ note 1}$	-	-	-1.1	٧
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V}; f = 100 \text{ MHz}$	100	_	_	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	-		40	pF

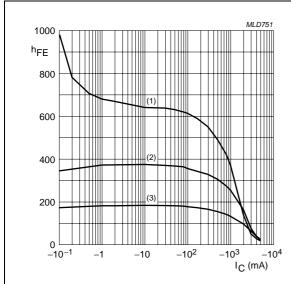
Note

1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

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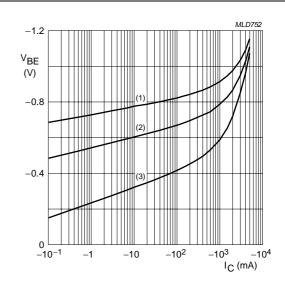
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 $V_{CE} = -2 V$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

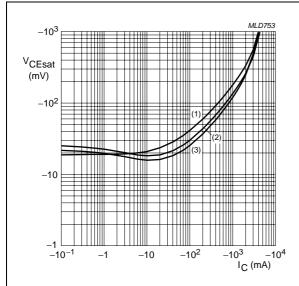
Fig.2 DC current gain as a function of collector current; typical values.



 $V_{CE} = -2 V$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

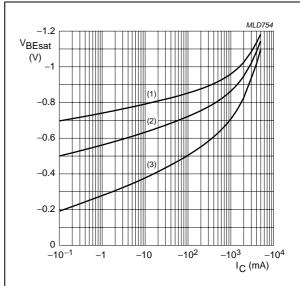
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



 $I_{C}/I_{B} = 20.$

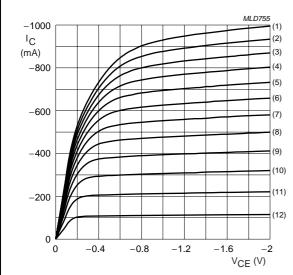
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- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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 T_{amb} = 25 °C.

(1) $I_B = -3.96 \text{ nA}.$

(5) $I_B = -2.64 \text{ nA}.$

(9) $I_B = -1.32 \text{ nA}.$

(2) $I_B = -3.63 \text{ nA}.$

(6) $I_B = -2.31 \text{ nA}.$

(10) $I_B = -0.99 \text{ nA}.$

(3) $I_B = -3.30 \text{ nA}.$

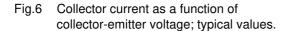
(7) $I_B = -1.98 \text{ nA}.$

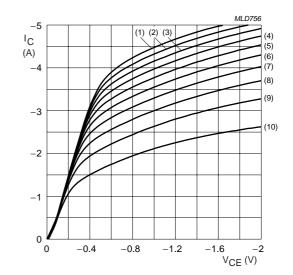
(11) $I_B = -0.66 \text{ nA}$.

(4) $I_B = -2.97 \text{ nA}.$

(8) $I_B = -1.65 \text{ nA}$.

(12) $I_B = -0.33 \text{ nA}.$





 $T_{amb} = 25 \, ^{\circ}C.$

(1) $I_B = -250 \text{ mA}.$

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(5) $I_B = -150 \text{ mA}.$

(9) $I_B = -50 \text{ mA}.$

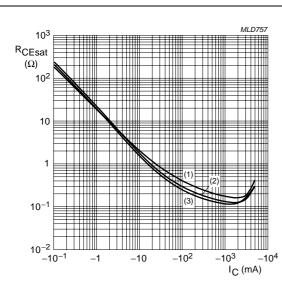
(2) $I_B = -225 \text{ mA}.$

(6) $I_B = -125 \text{ mA}.$

(10) $I_B = -25 \text{ mA}.$

(3) $I_B = -200 \text{ mA}$. (4) $I_B = -175 \text{ mA}$. (7) $I_B = -100 \text{ mA}.$ (8) $I_B = -75 \text{ mA}.$

Fig.7 Collector current as a function of collector-emitter voltage; typical values.



 $I_{C}/I_{B} = 20.$

(1) $T_{amb} = 150 \, ^{\circ}\text{C}$. (2) $T_{amb} = 25 \, ^{\circ}\text{C}$. (3) $T_{amb} = -55 \, ^{\circ}\text{C}$.

Fig.8 Collector-emitter equivalent on-resistance as a function of collector current; typical values.

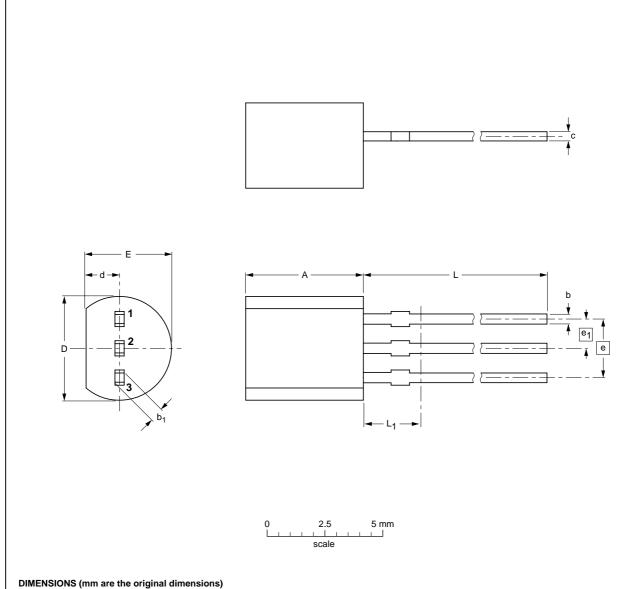
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PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



UNIT	Α	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE	
SOT54		TO-92	SC-43A			-04-06-28 04-11-16	

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DATA SHEET STATUS

DOCUMENT STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

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